

ART FILM - TOP

ART FILM - L2





ART FILM - BOTTOM



ART FILM - BOTTOM

ART FILM - BOTTOM_MASK



ART FILM - BOTTOM_MASK

ART FILM - BOTTOM_PASTE



ART FILM - BOTTOM_PASTE

NET BILM DOWNON CITY

C17

ART FILM - BOTTOM SILK

ART FILM - BOTTOM_SILK

ART FILM - TOP_MASK



ART FILM - TOP_MASK

ART FILM - TOP_PASTE



ART FILM - TOP_PASTE

ART FILM - TOP_SILK



ART FILM - TOP_SILK

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1.30	

DRILL CHART: TOP to BOTTOM					
	ALL UNITS ARE IN MILS				
FIGURE	SIZE	TOLERANCE	PLATED	QTY	
	8.0	+ 3 . 0 / - 3 . 0	PLATED	39	
0	28.0	+ 3 . 0 / - 3 . 0	PLATED	9	
В	91.0	+ 3 . 0 / - 3 . 0	PLATED	2	
	43.31	+2.0/-2.0	NON-PLATED	2	
	98.43×39.37	+ 3 . 0 / - 3 . 0	PLATED	2	

ART FILM - L3





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